

## 45V $I_o=200\text{mA}$ Ultra low Quiescent current LDO

### FEATURES

- AEC-Q100 grade 1 (T1 specification only)
- Low Quiescent Current       $5.5\mu\text{A typ. (A version)}$   
    $5.0\mu\text{A typ. (B version)}$
- Operating Voltage             $4.0\text{V to }40\text{V}$
- Operating Temperature       $T_a=-40^\circ\text{C to }125^\circ\text{C}$
- Output Voltage Accuracy     $V_o \pm 1.0\% (T_a=25^\circ\text{C})$   
    $V_o \pm 2.0\% (T_a=-40^\circ\text{C to }125^\circ\text{C})$
- Output Current                 $I_o(\text{min.})=200\text{mA}$
- ON/OFF Control                A ver. only
- Correspond to MLCC
- Under Voltage Lock Out circuit
- Thermal Shutdown Circuit
- Over Current Protection Circuit
- Package Outline                A ver. SOT-89-5-2  
   B ver. SOT-89-3, TO-252-3-L1

### GENERAL DESCRIPTION

NJW4104 is a 45V  $I_o=200\text{mA}$  ultra low quiescent current low dropout regulator.

It achieves low quiescent current characteristics, therefore it contributes to reduce current consumption of applications.

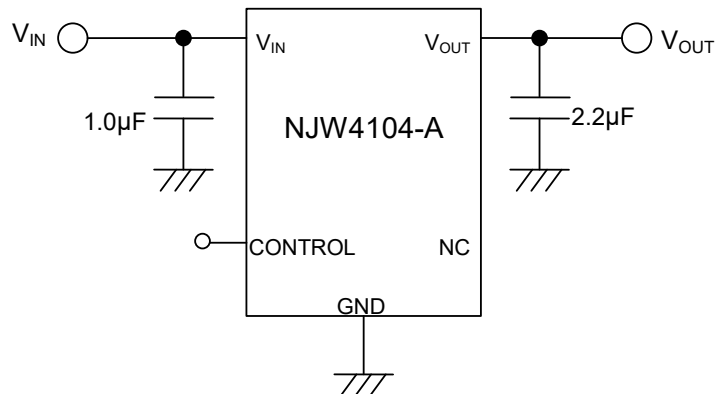
Output Voltage is guaranteed  $\pm 2\%$  under wide range conditions:  $V_{IN}=V_o+1\text{V to }40\text{V}$ ,  $I_o=0$  to  $200\text{mA}$  and  $T_a=-40^\circ\text{C to }125^\circ\text{C}$ .

Because of wide input voltage range and wide operating temperature range, the NJW4104 is suitable for various applications including automotive applications.

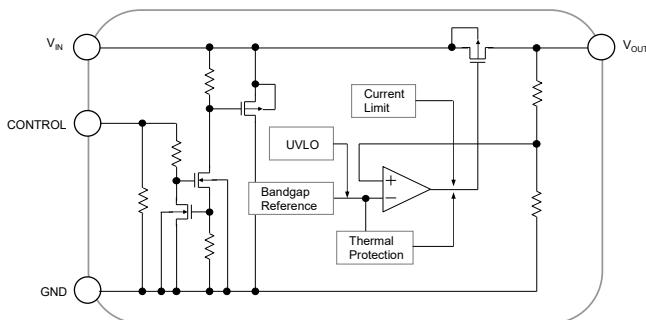
### APPLICATION

- Automotive infotainment
- Automotive ECU unit
- Industrial equipment

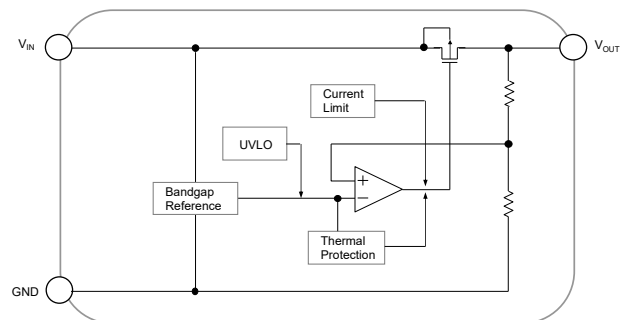
### TYPICAL APPLICATION



### BLOCK DIAGRAM



A version



B version

## OUTPUT VOLTAGE RANK

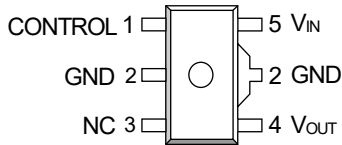
SOT-89-5-2

SOT-89-3

TO-252-3-L1

PART NUMBER	OUTPUT VOLTAGE	PART NUMBER	OUTPUT VOLTAGE	PART NUMBER	OUTPUT VOLTAGE
NJW4104U2-33A / -T1	3.3V	NJW4104U3-33B / -T1	3.3V	NJW4104DL1-33B	3.3V
NJW4104U2-05A / -T1	5.0V	NJW4104U3-05B / -T1	5.0V	NJW4104DL1-05B	5.0V

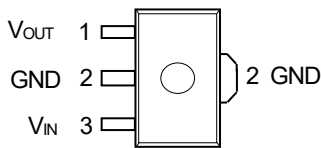
## PIN CONFIGURATION



SOT-89-5-2

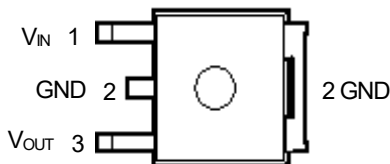
PIN NO.	SYMBOL	DESCRIPTION
1	CONTROL	ON/OFF Control
2	GND	Ground
3	NC	No Connection*
4	V <sub>OUT</sub>	Output
5	V <sub>IN</sub>	Input

\*Note) NC pin is not connect to internally circuit. This pin can be open or connected to ground. Connecting to ground is recommended to improve thermal dissipation.



SOT-89-3

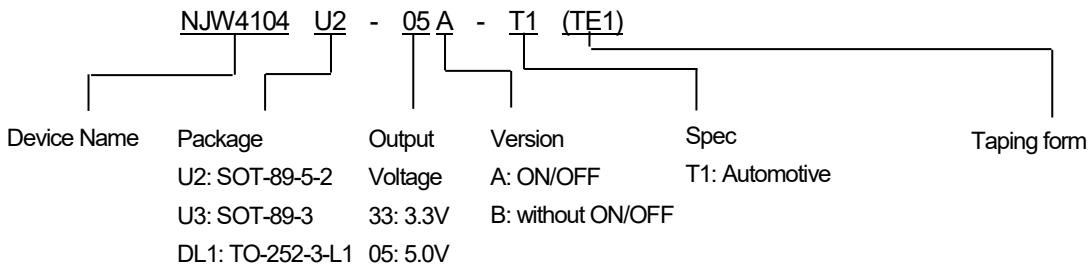
PIN NO.	SYMBOL	DESCRIPTION
1	V <sub>OUT</sub>	Output
2	GND	Ground
3	V <sub>IN</sub>	Input



TO-252-3-L1

PIN NO.	SYMBOL	DESCRIPTION
1	V <sub>IN</sub>	Input
2	GND	Ground
3	V <sub>OUT</sub>	Output

## PRODUCT NAME INFORMATION



**ORDERING INFORMATION**

PRODUCT NAME	OUTPUT VOLTAGE	PACKAGE OUTLINE	AUTOMOTIVE SPEC	RoHS	HALOGEN -FREE	TERMINAL FINISH	MARKING	WEIGHT (mg)	MOQ (pcs)
NJW4104U2-33A(Te1)	3.3V	SOT-89-5-2	-	yes	yes	Sn-2Bi	231	61	1000
NJW4104U2-05A(Te1)	5.0V	SOT-89-5-2	-	yes	yes	Sn-2Bi	241	61	1000
NJW4104U2-33A-T1(Te1)	3.3V	SOT-89-5-2	yes	yes	yes	Sn-2Bi	251	61	1000
NJW4104U2-05A-T1(Te1)	5.0V	SOT-89-5-2	yes	yes	yes	Sn-2Bi	261	61	1000
NJW4104U3-33B(Te1)	3.3V	SOT-89-3	-	yes	yes	Sn-2Bi	33S	61	1000
NJW4104U3-05B(Te1)	5.0V	SOT-89-3	-	yes	yes	Sn-2Bi	50S	61	1000
NJW4104U3-33B-T1(Te1)	3.3V	SOT-89-3	yes	yes	yes	Sn-2Bi	33U	61	1000
NJW4104U3-05B-T1(Te1)	5.0V	SOT-89-3	yes	yes	yes	Sn-2Bi	50U	61	1000
NJW4104DL1-33B(Te1)	3.3V	TO-252-3-L1	-	yes	yes	Sn-2Bi	04B33	301	3000
NJW4104DL1-05B(Te1)	5.0V	TO-252-3-L1	-	yes	yes	Sn-2Bi	04B05	301	3000

Note) "-" is non-evaluation. Please contact your sales representative for more information. Note) AEC-Q100 grade 1 T1 specification only

**ABSOLUTE MAXIMUM RATINGS**

PARAMETER	SYMBOL	RATINGS	UNIT
Input Voltage	V <sub>IN</sub>	-0.3 to +45	V
Control Pin Voltage <sup>(1)</sup>	V <sub>CONT</sub>	-0.3 to +45	V
Output Voltage	V <sub>OUT</sub>	-0.3 to V <sub>IN</sub> ≤ +17	V
Power Dissipation(Ta=25°C)	P <sub>D</sub>	(2-layer / 4-layer)	mW
SOT-89		625 <sup>(2)</sup> / 2400 <sup>(3)</sup>	
TO-252		1190 <sup>(2)</sup> / 3125 <sup>(3)</sup>	
Junction Temperature Range	T <sub>j</sub>	-40 to +150	°C
Operating Temperature Range	T <sub>opr</sub>	-40 to +125	°C
Storage Temperature Range	T <sub>stg</sub>	-50 to +150	°C

(1): Applied for A version.

(2): Mounted on glass epoxy board. (76.2×114.3×1.6mm: based on EIA/JEDEC standard, 2Layers)

(3): Mounted on glass epoxy board. (76.2×114.3×1.6mm: based on EIA/JEDEC standard, 4Layers), internal Cu area: 74.2x74.2mm  
(For 4Layers :Applying 74.2 x 74.2mm inner Cu area and thermal via holes to board based on JEDEC standard JESD51-5)

**RECOMMENDED OPERATING CONDITIONS**

PARAMETER	SYMBOL	VALUE	UNIT
Operating Voltage Range	V <sub>IN</sub>	4.0 to 40	V
Control Voltage	V <sub>CONT</sub>	0 to 40	V

**■ELECTRICAL CHARACTERISTICS**

 Unless other noted,  $V_{IN} = V_O + 1V$ ,  $C_{IN} = 1.0\mu F$ ,  $C_O = 2.2\mu F$ ,  $T_a = 25^\circ C$ 

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	単位	
Output Voltage	$V_O$	$V_{IN} = V_O + 1V$ to 40V, $I_O = 0mA$ to 200mA,	-1.0%	-	+1.0%	V	
		$V_{IN} = V_O + 1V$ to 40V, $I_O = 0mA$ to 200mA, $T_a = -40^\circ C$ to $+125^\circ C$	-2.0%	-	+2.0%		
Quiescent Current	$I_Q$	A version, $I_O = 0mA$ , except $I_{CONT}$	-	5.5	9.5	$\mu A$	
		A version, $I_O = 0mA$ , except $I_{CONT}$ , $T_a = -40^\circ C$ to $+125^\circ C$	-	-	13.5		
		B version, $I_O = 0mA$	-	5.0	8.5		
		B version, $I_O = 0mA$ , $T_a = -40^\circ C$ to $+125^\circ C$	-	-	12		
Quiescent Current at Control OFF (4)	$I_{Q(OFF)}$	$V_{CONT} = 0V$	-	-	1	$\mu A$	
		$V_{CONT} = 0V$ , $T_a = -40^\circ C$ to $+125^\circ C$	-	-	1		
Output Current	$I_O$	$V_O \times 0.9$	200	-	-	mA	
		$V_O \times 0.9$ , $T_a = -40^\circ C$ to $+125^\circ C$	200	-	-		
Line Regulation	$\Delta V_O / \Delta V_{IN}$	$V_{IN} = V_O + 1V$ to 40V, $I_O = 30mA$	$V_O = 3.3V$	-	-	23.5	mV
			$V_O = 5.0V$	-	-	34	
		$V_{IN} = V_O + 1V$ to 40V, $I_O = 30mA$ , $T_a = -40^\circ C$ to $+125^\circ C$	$V_O = 3.3V$	-	-	35.3	
			$V_O = 5.0V$	-	-	51	
Load Regulation	$\Delta V_O / \Delta I_O$	$I_O = 0mA$ to 200mA	$V_O = 3.3V$	-	-	15.2	mV
			$V_O = 5.0V$	-	-	23	
		$I_O = 0mA$ to 200mA, $T_a = -40^\circ C$ to $+125^\circ C$	$V_O = 3.3V$	-	-	26.4	
			$V_O = 5.0V$	-	-	40	
Ripple Rejection	RR	$V_{IN} = 7.0V$ , $e_{in} = 200mV_{rms}$ , $f = 1kHz$ , $I_O = 10mA$	$V_O = 3.3V$	-	41	-	dB
			$V_O = 5.0V$	-	36	-	
Dropout Voltage (5)	$\Delta V_{IO}$	$I_O = 100mA$	-	0.18	0.25	V	
		$I_O = 100mA$ , $T_a = -40^\circ C$ to $+125^\circ C$	-	-	0.46		
Control Current (4)	$I_{CONT}$	$V_{CONT} = 1.6V$	-	0.5	2	$\mu A$	
		$V_{CONT} = 1.8V$ , $T_a = -40^\circ C$ to $+125^\circ C$	-	-	3		
Control Voltage for ON-state (4)	$V_{CONT(ON)}$		1.6	-	-	V	
		$T_a = -40^\circ C$ to $+125^\circ C$	1.8	-	-		
Control Voltage for OFF-state (4)	$V_{CONT(OFF)}$		-	-	0.6	V	
		$T_a = -40^\circ C$ to $+125^\circ C$	-	-	0.6		
UVLO Release Voltage	$V_{UVLO}$	$V_{IN} = L \rightarrow H$	2.4	2.8	3.3	V	
		$V_{IN} = L \rightarrow H$ , $T_a = -40^\circ C$ to $+125^\circ C$	2.1	-	3.5		
UVLO Hysteresis Voltage	$V_{HYS}$	$V_{IN} = H \rightarrow L$	70	200	-	mV	
		$V_{IN} = H \rightarrow L$ , $T_a = -40^\circ C$ to $+125^\circ C$	70	-	-		
Average Temperature Coefficient of Output Voltage	$\Delta V_O / \Delta T_a$	$T_a = -40^\circ C$ to $125^\circ C$ , $I_O = 30mA$	-	$\pm 50$	-	ppm/ $^\circ C$	

(4): Applied for A version.

(5): Except Output Voltage Rank less than 3.8V

 Characteristics values of defined as  $T_a = -40^\circ C$  to  $+125^\circ C$  are applied only "T1" spec.

■ THERMAL CHARACTERISTICS

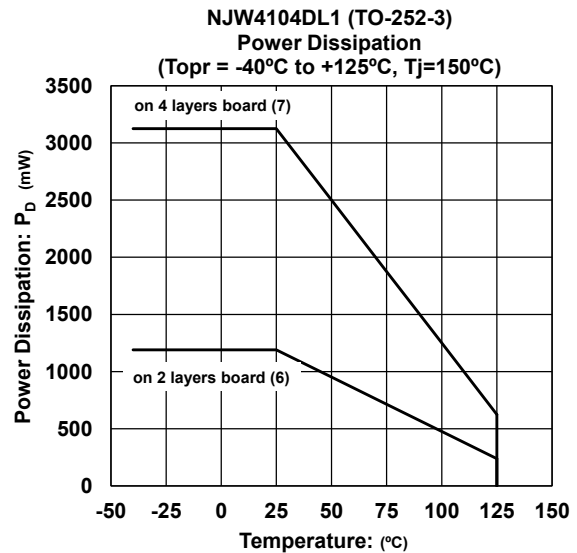
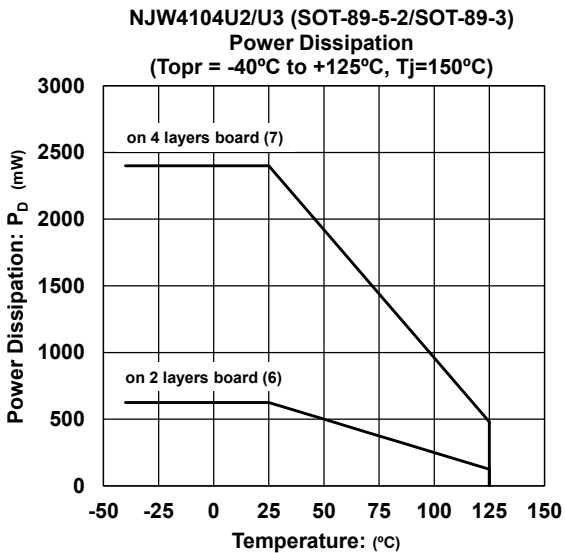
PARAMETER	SYMBOL	VALUE	UNIT	
Junction-to-ambient thermal resistance	$\theta_{ja}$	SOT-89-3/-5-2	200 <sup>(6)</sup> 52 <sup>(7)</sup>	°C/W
		TO-252-3-L1	105 <sup>(6)</sup> 40 <sup>(7)</sup>	
Junction-to-Top of package characterization parameter	$\psi_{jt}$	SOT-89-3/-5-2	43 <sup>(6)</sup> 19 <sup>(7)</sup>	°C/W
		TO-252-3-L1	17 <sup>(6)</sup> 12 <sup>(7)</sup>	

(6): Mounted on glass epoxy board. (76.2×114.3×1.6mm: based on EIA/JEDEC standard, 2Layers)

(7): Mounted on glass epoxy board. (76.2×114.3×1.6mm: based on EIA/JEDEC standard, 4Layers), internal Cu area: 74.2x74.2mm

(For 4Layers :Applying 74.2 x 74.2mm inner Cu area and thermal via holes to board based on JEDEC standard JESD51-5)

■ POWER DISSIPATION vs. AMBIENT TEMPERATURE



**\*Input Capacitor  $C_{IN}$**

The input capacitor  $C_{IN}$  is required in order to prevent oscillation and reduce power supply ripple of applications when high power supply impedance or a long power supply line.

Therefore, the recommended capacitance (refer to conditions of ELECTRIC CHARACTERISTIC) or larger input capacitor, connected between  $V_{IN}$  and GND as short path as possible, is recommended in order to avoid the problem.

**\*Output Capacitor  $C_O$**

The output capacitor  $C_O$  is required for a phase compensation of the internal error amplifier, and the capacitance and the equivalent series resistance (ESR) influence stable operation of the regulator.

If use a smaller output capacitor than the recommended capacitance (refer to conditions of ELECTRIC CHARACTERISTIC), it may cause excess output noise or oscillation of the regulator due to lack of the phase compensation. Therefore, the recommended capacitance or larger output capacitor, connected between  $V_{OUT}$  and GND as short path as possible, is recommended for stable operation. The recommended capacitance may be different by output voltage, therefore confirm the recommended capacitance of the required output voltage.

Furthermore, a larger output capacitor reduces output noise and ripple output, and also improves Output Transient Response when a load changes rapidly.

Selecting the output capacitor, should consider varied characteristics of a capacitor: frequency characteristics, temperature characteristics, DC bias characteristics and so on. Therefore, the capacitor that has a sufficient margin of the rated voltage against the output voltage and superior temperature characteristics, is recommended for  $C_O$ .

**\*Transient Response of Output Voltage**

In general, the regulator tends to cause overshoot or undershoot of output voltage at the following conditions.

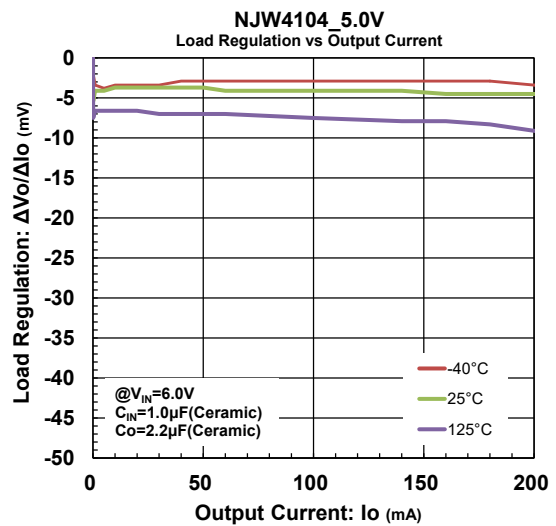
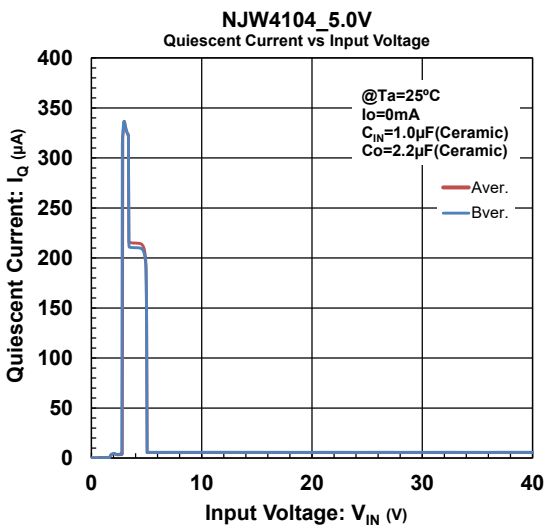
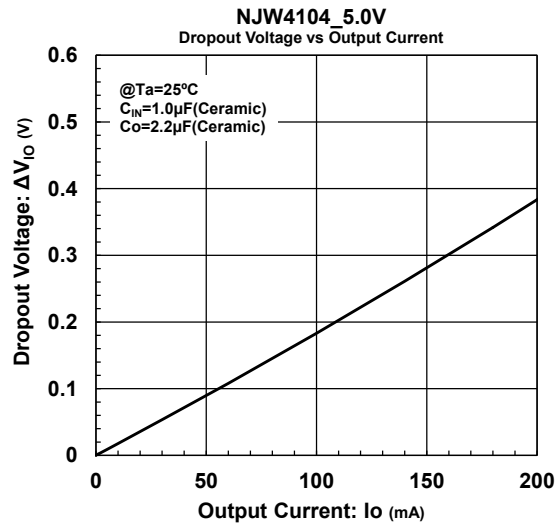
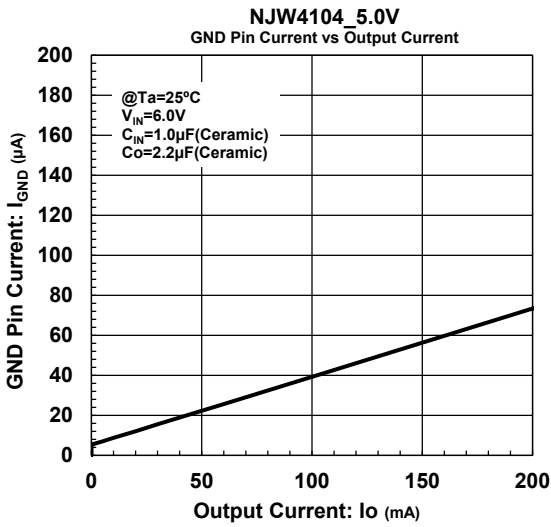
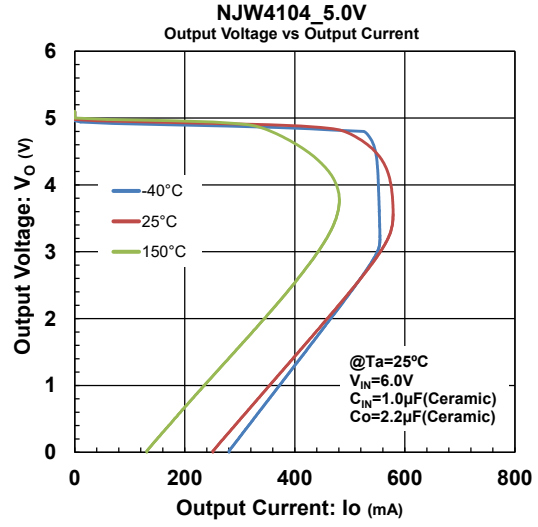
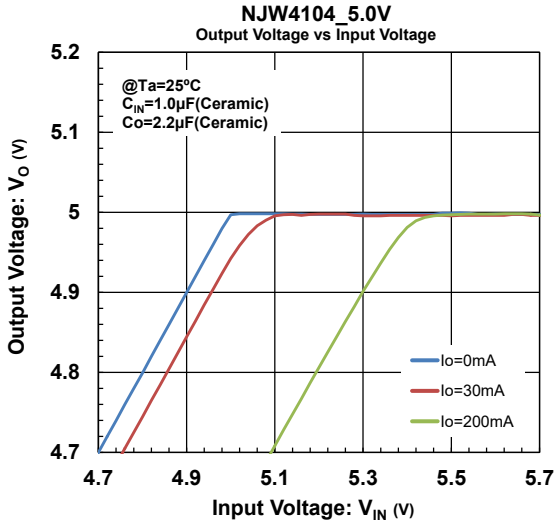
Particularly in products featuring low current consumption, the output voltage fluctuation may become large due to product characteristics.

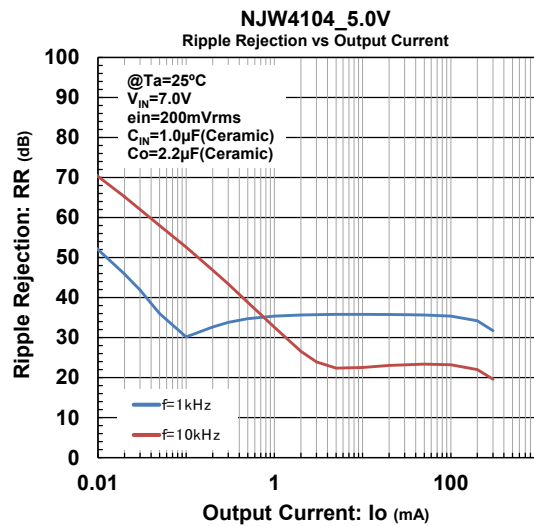
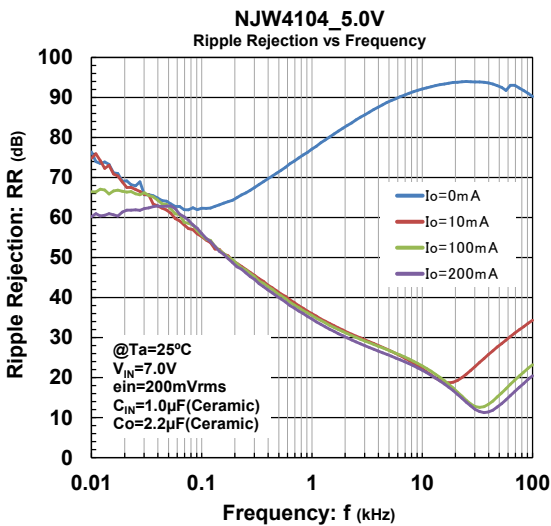
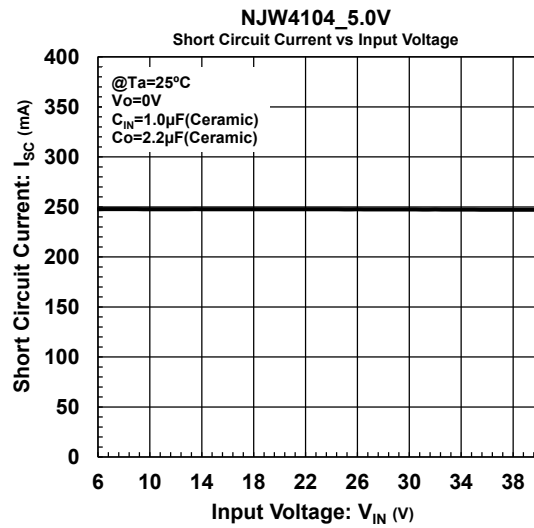
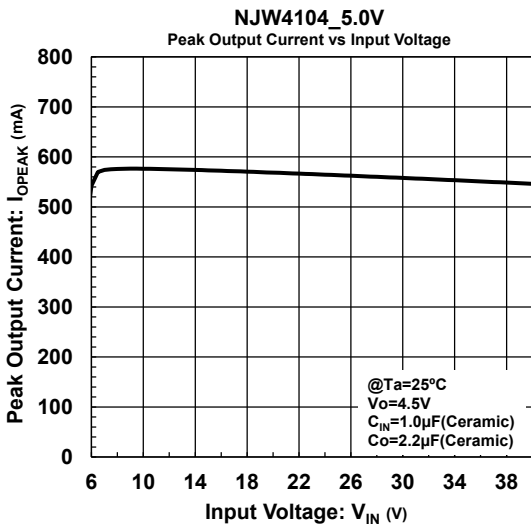
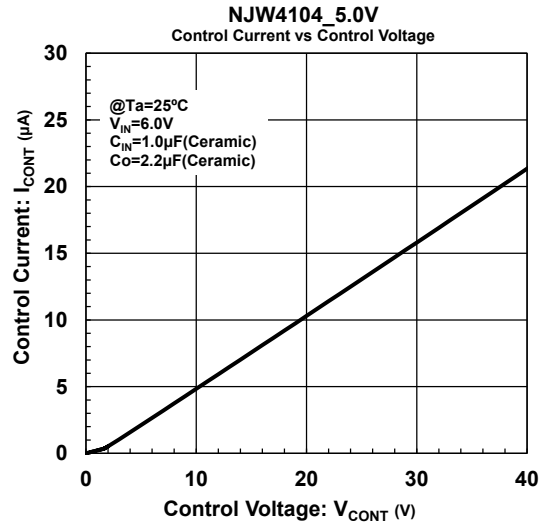
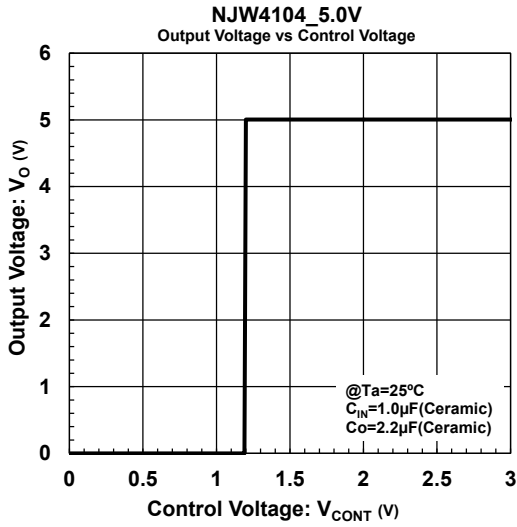
- When input voltage or output current fluctuate sharply
- When output capacitance is small
- When output load is light
- When start up from the condition of narrow voltage difference between an Input and an output.

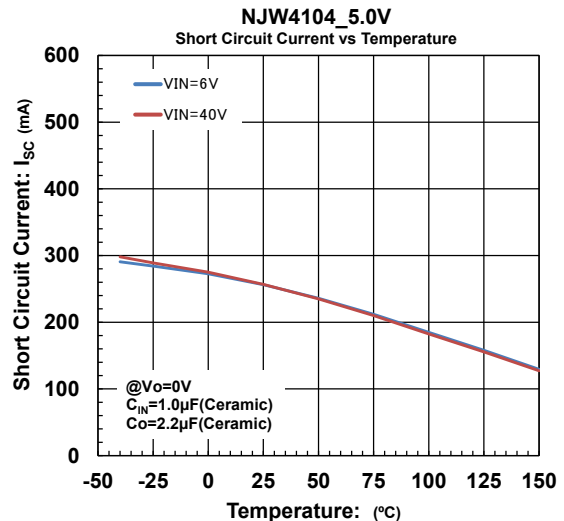
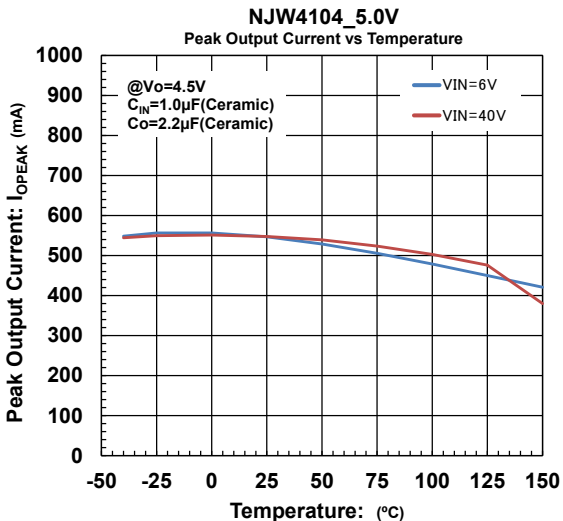
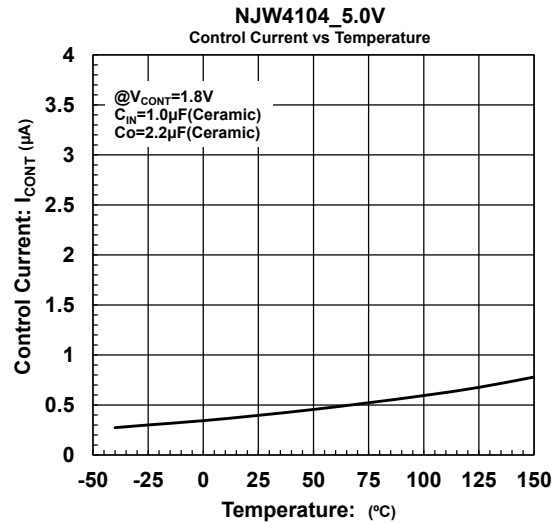
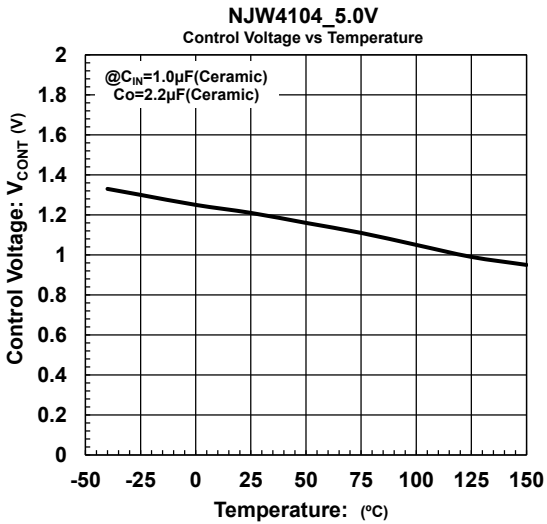
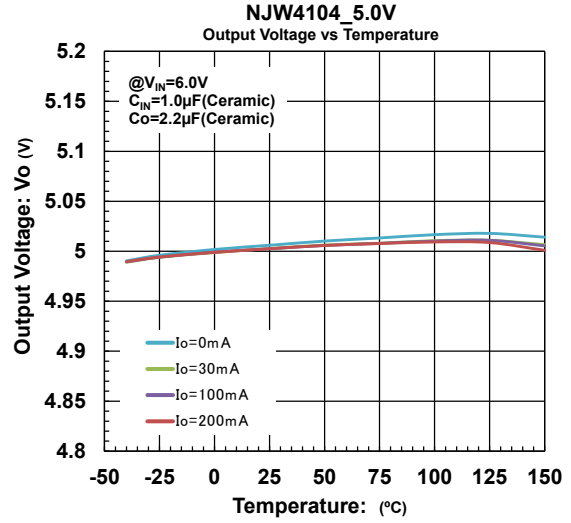
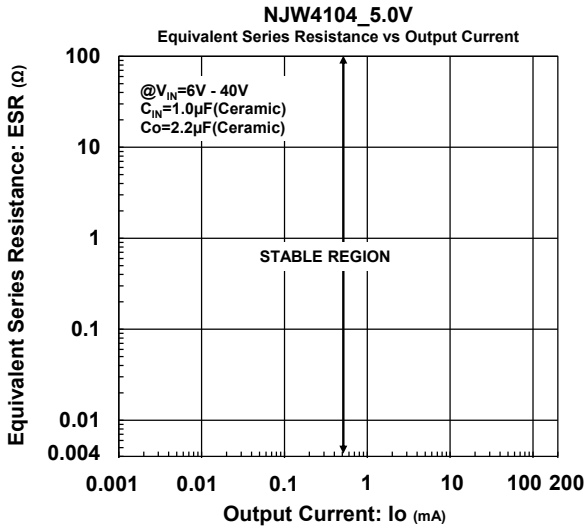
One way to improve transient response is to use a large capacity input and output capacitors to suppress to the fluctuation.

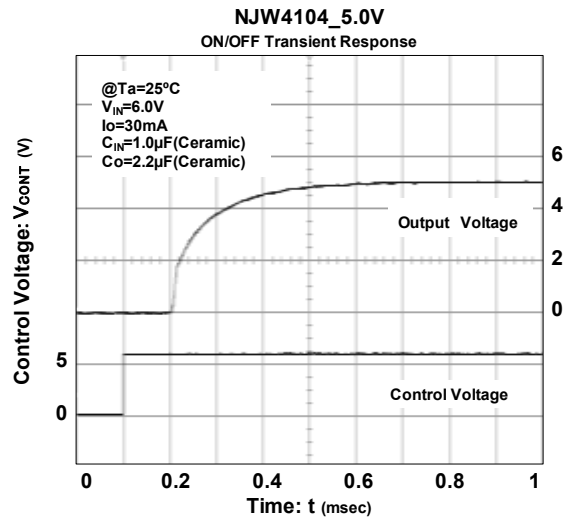
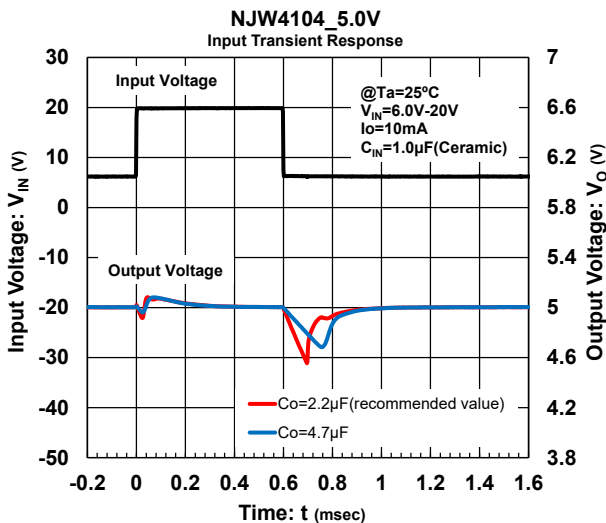
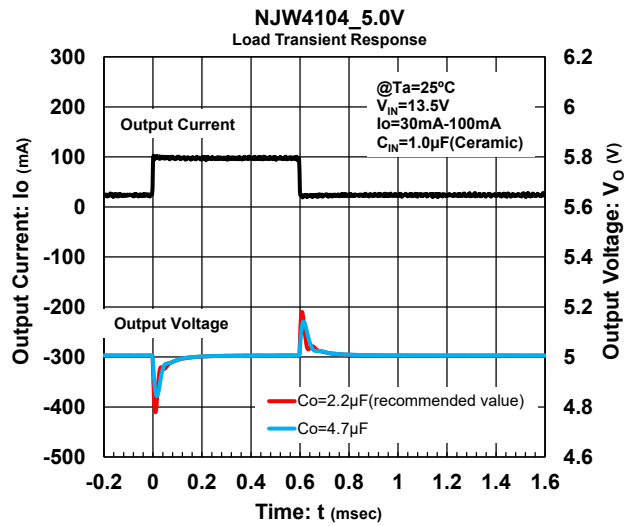
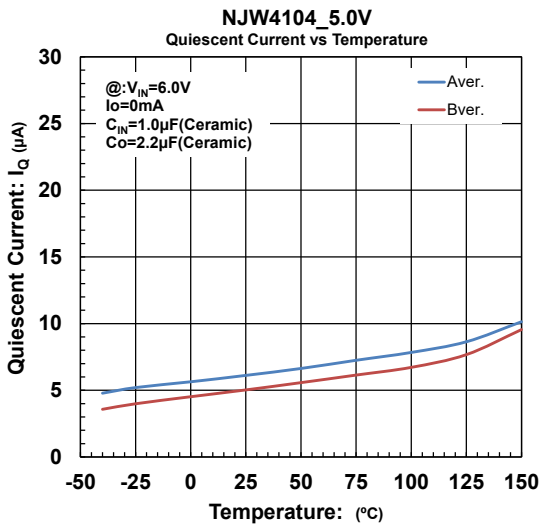
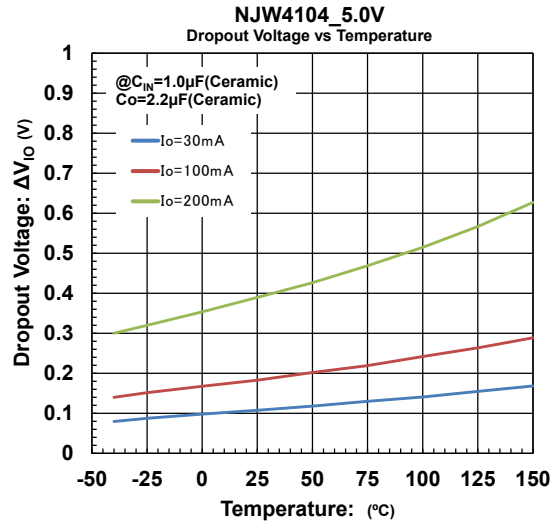
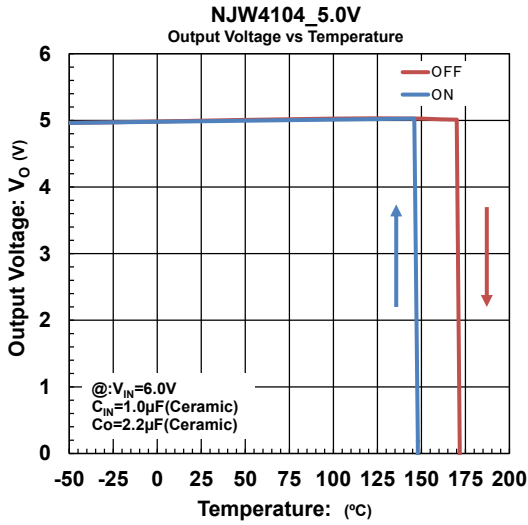
Amount of transient fluctuation will change according to multiple conditions, so please refer to the above to confirm with actual equipment.

■ TYPICAL CHARACTERISTICS





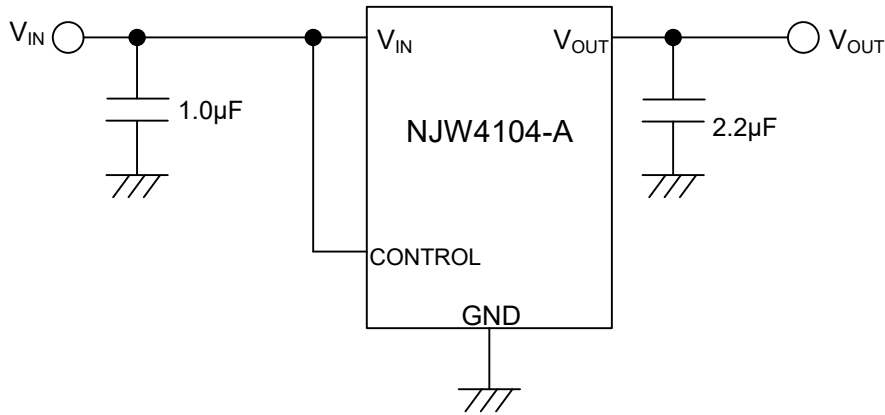




■ **TYPICAL APPLICATION**

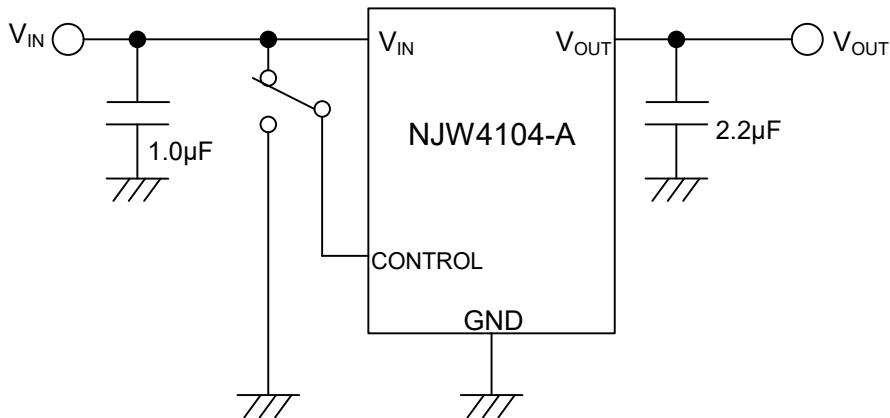
● **A version**

1. In the case where ON/OFF Control is not required



Connect CONTROL Pin to V<sub>IN</sub> Pin

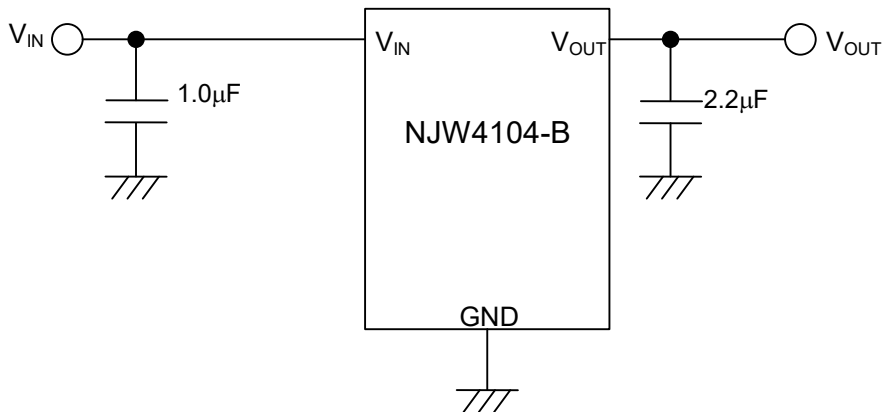
2. In use of ON/OFF CONTROL



State of CONTROL Pin:

“H” → output is enabled. “L” or “open” → output is disabled

● **B version**



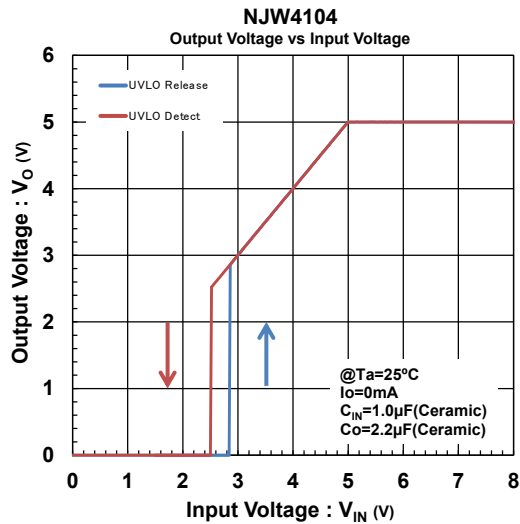
■APPLICATION NOTE / GLOSSARY

\*Under Voltage Lockout UVLO

The NJW4104 includes UVLO circuit to prevent malfunction in case of low input voltage.

When the input voltage increases and exceeds the “UVLO Release voltage” (2.8V typ.),UVLO is released and the output voltage rises up.

The UVLO circuit has hysteresis(200mV typ.). Therefore, if the input voltage decreases below the threshold voltage:“UVLO Release voltage” – “UVLO Hysteresis Voltage”, the output voltage shuts down.



■REVISION HISTORY

Date	Revision	Changes
04.Apr.2017.	Ver.1.0	New Release
27.Aug,2018	Ver.1.1	Correction of erroneous description
17.Mar,2023	Ver.2.0	■AEC-Q100 grade 1 Added

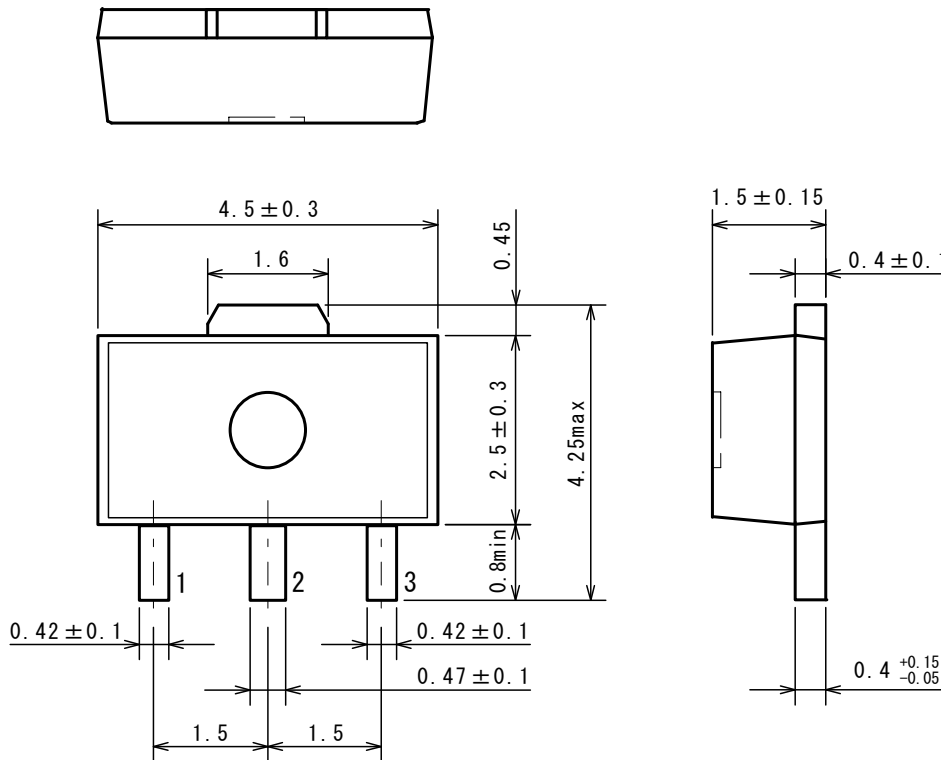
# Nisshinbo Micro Devices Inc.

SOT-89-3

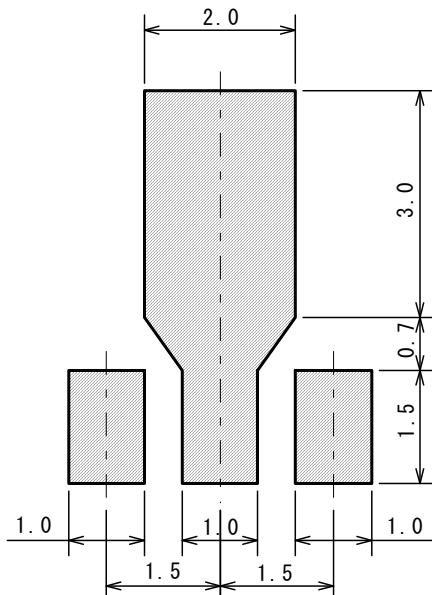
PI-SOT-89-3-E-B

## ■ PACKAGE DIMENSIONS

UNIT: mm



## ■ EXAMPLE OF SOLDER PADS DIMENSIONS



# Nisshinbo Micro Devices Inc.

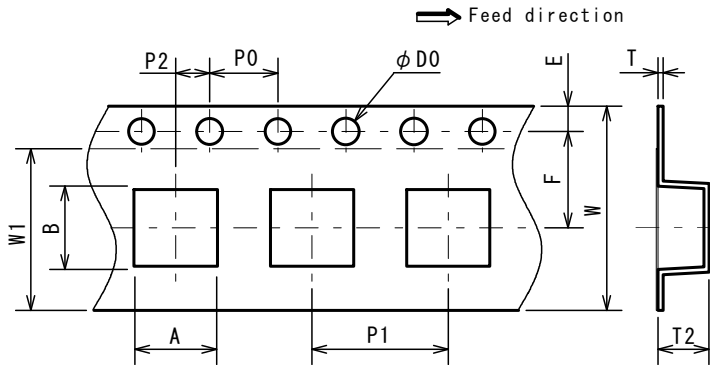
SOT-89-3

PI-SOT-89-3-E-B

■ PACKING SPEC

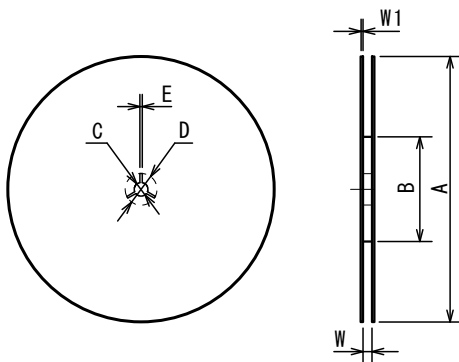
UNIT: mm

TAPING DIMENSIONS



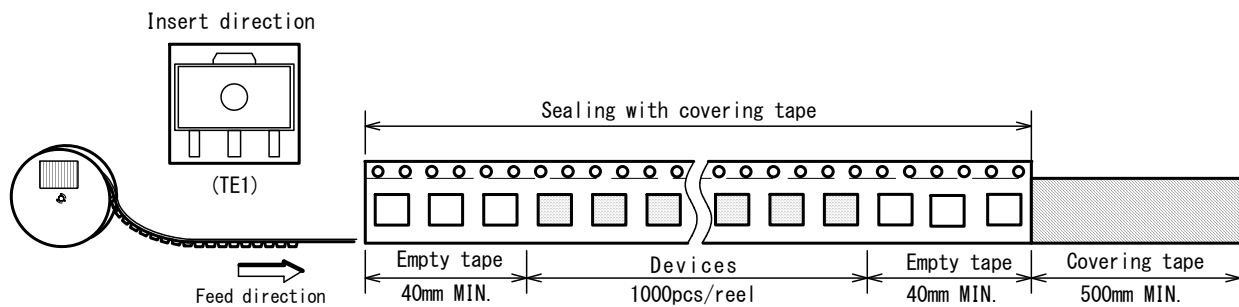
SYMBOL	DIMENSION	REMARKS
A	4.9±0.1	BOTTOM DIMENSION
B	4.5±0.1	BOTTOM DIMENSION
D0	1.5 <sup>+0.1</sup> <sub>0</sub>	
E	1.5±0.1	
F	5.65±0.05	
P0	4.0±0.1	
P1	8.0±0.1	
P2	2.0±0.05	
T	0.3±0.05	
T2	2.0	
W	12.0±0.3	
W1	9.5	THICKNESS 0.1MAX

REEL DIMENSIONS

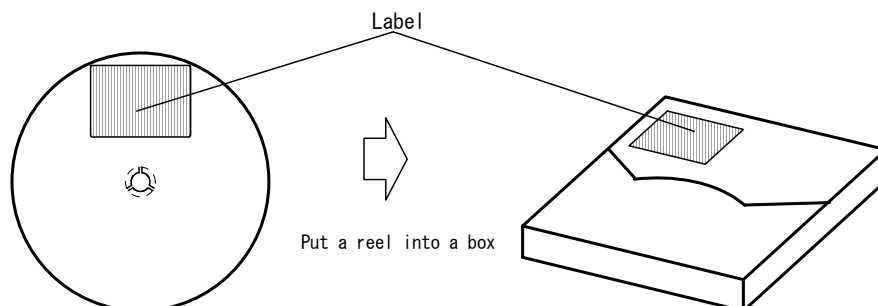


SYMBOL	DIMENSION
A	φ180±1
B	φ60±1
C	φ13±0.2
D	φ21±0.8
E	2±0.5
W	13±0.5
W1	1.2±0.2

TAPING STATE



PACKING STATE



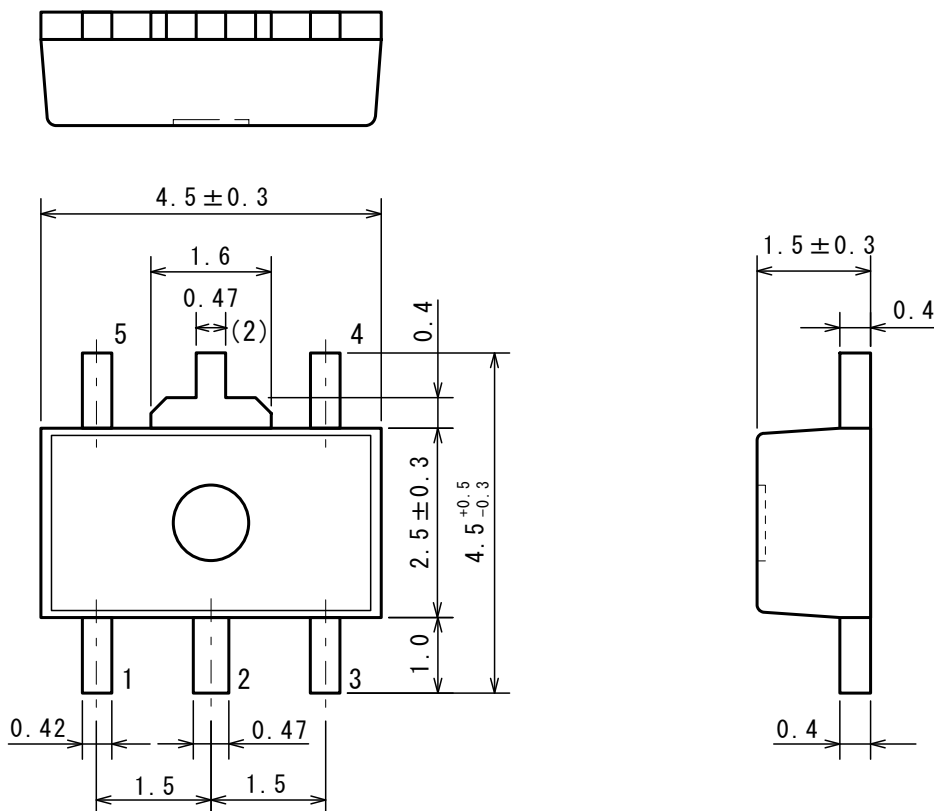
# Nisshinbo Micro Devices Inc.

SOT-89-5-1 / SOT-89-5-2

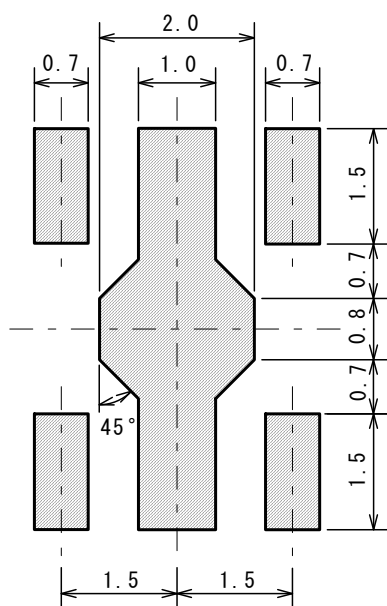
PI-SOT-89-5-1 / SOT-89-5-2-E-B

## ■ PACKAGE DIMENSIONS

UNIT: mm



## ■ EXAMPLE OF SOLDER PADS DIMENSIONS



# Nisshinbo Micro Devices Inc.

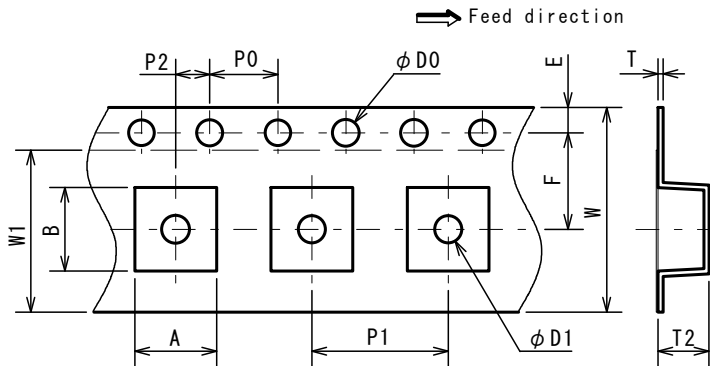
SOT-89-5-1 / SOT-89-5-2

PI-SOT-89-5-1 / SOT-89-5-2-E-B

## PACKING SPEC

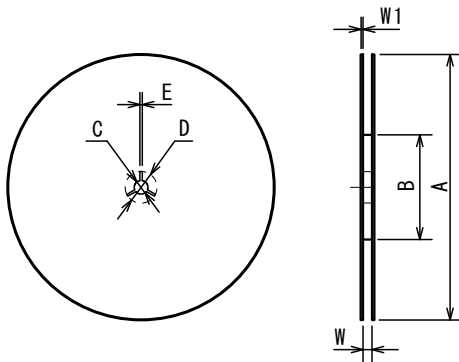
UNIT: mm

### TAPING DIMENSIONS



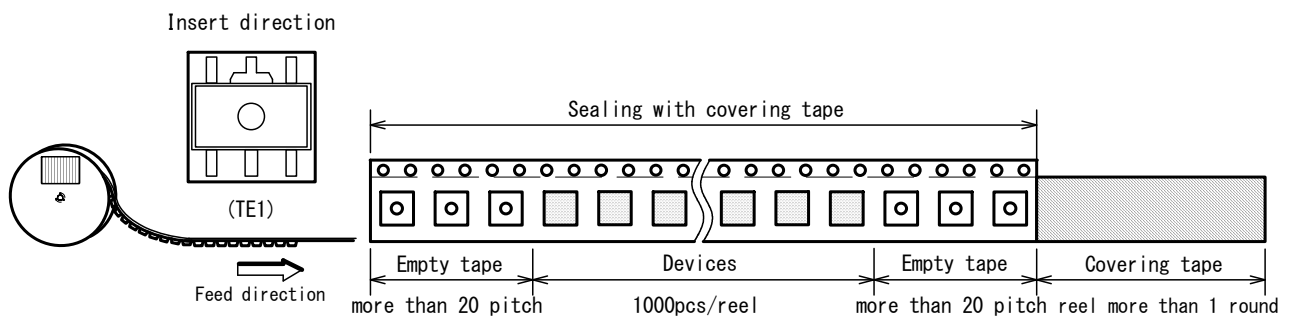
SYMBOL	DIMENSION	REMARKS
A	4.8±0.1	BOTTOM DIMENSION
B	4.9±0.1	BOTTOM DIMENSION
D0	1.5 <sup>+0.1</sup> <sub>0</sub>	
D1	1.6	
E	1.5±0.1	
F	5.65±0.1	
P0	4.0±0.1	
P1	8.0±0.1	
P2	2.0±0.1	
T	0.30±0.05	
T2	2.0±0.1	
W	12.0±0.3	
W1	9.5	THICKNESS 0.1MAX

### REEL DIMENSIONS

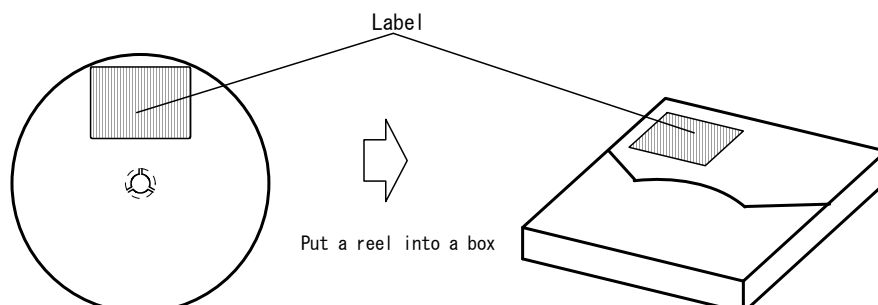


SYMBOL	DIMENSION
A	φ 180±1
B	φ 60±1
C	φ 13±0.2
D	φ 21±0.8
E	2±0.5
W	13±0.5
W1	1.2±0.2

### TAPING STATE

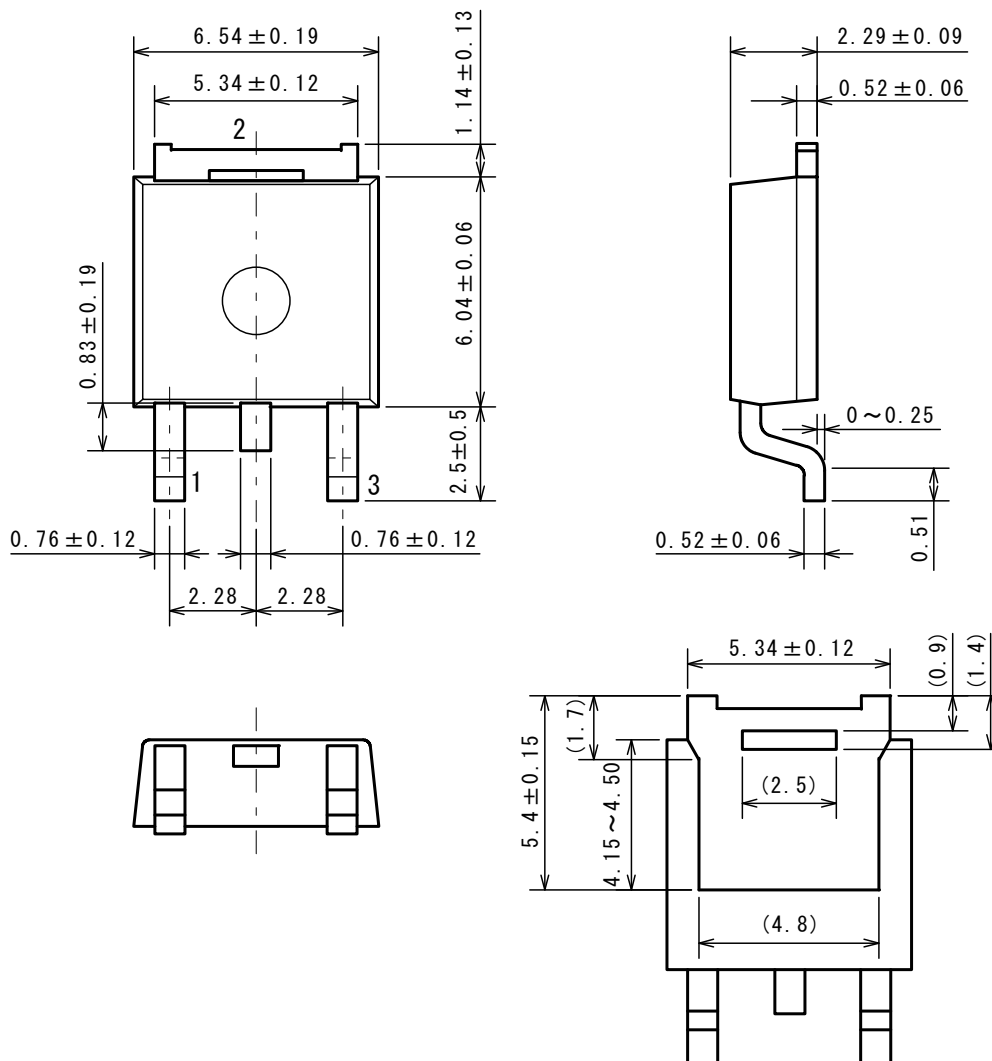


### PACKING STATE

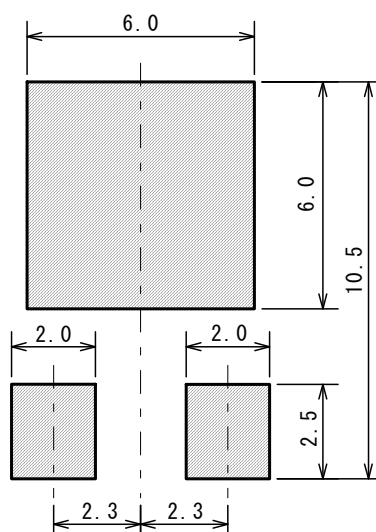


■ PACKAGE DIMENSIONS

UNIT: mm



■ EXAMPLE OF SOLDER PADS DIMENSIONS



# Nisshinbo Micro Devices Inc.

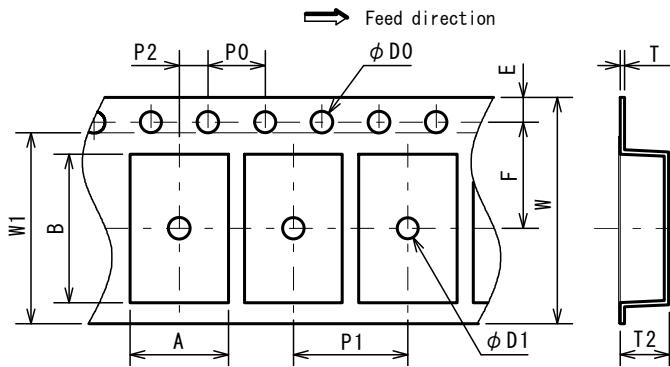
TO-252-3-L1

PI-TO-252-3-L1-E-B

■ PACKING SPEC

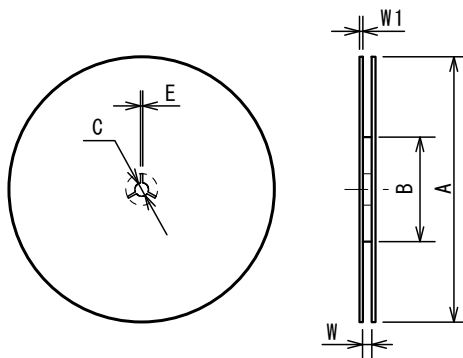
UNIT: mm

TAPING DIMENSIONS



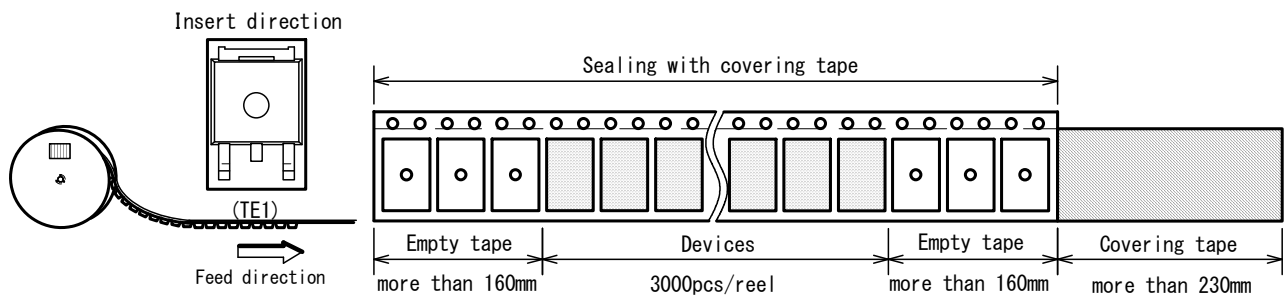
SYMBOL	DIMENSION	REMARKS
A	6.9±0.1	BOTTOM DIMENSION
B	10.5±0.1	BOTTOM DIMENSION
D0	1.5 <sup>+0.1</sup> <sub>0</sub>	
D1	1.5 <sup>+0.1</sup> <sub>0</sub>	
E	1.75±0.1	
F	7.5±0.1	
P0	4.0±0.1	
P1	8.0±0.1	
P2	2.0±0.1	
T	0.3±0.1	
T2	3.4 max	
W	16.0±0.3	
W1	13.5	THICKNESS 0.1max

REEL DIMENSIONS

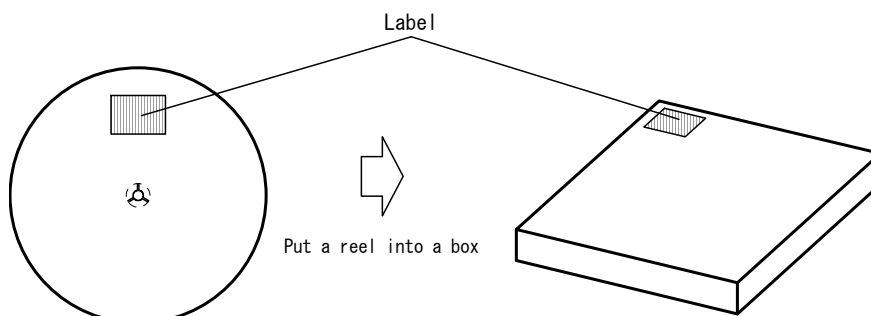


SYMBOL	DIMENSION
A	φ 330±2
B	φ 80±1
C	φ 13±0.5
E	2
W	17.5±0.5
W1	2±0.5

TAPING STATE



PACKING STATE



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8. **Quality Warranty**
  - 8-1. **Quality Warranty Period**  
In the case of a product purchased through an authorized distributor or directly from us, the warranty period for this product shall be one (1) year after delivery to your company. For defective products that occurred during this period, we will take the quality warranty measures described in section 8-2. However, if there is an agreement on the warranty period in the basic transaction agreement, quality assurance agreement, delivery specifications, etc., it shall be followed.
  - 8-2. **Quality Warranty Remedies**  
When it has been proved defective due to manufacturing factors as a result of defect analysis by us, we will either deliver a substitute for the defective product or refund the purchase price of the defective product.  
Note that such delivery or refund is sole and exclusive remedies to your company for the defective product.
  - 8-3. **Remedies after Quality Warranty Period**  
With respect to any defect of this product found after the quality warranty period, the defect will be analyzed by us. On the basis of the defect analysis results, the scope and amounts of damage shall be determined by mutual agreement of both parties. Then we will deal with upper limit in Section 8-2. This provision is not intended to limit any legal rights of your company.
9. Anti-radiation design is not implemented in the products described in this document.
10. The X-ray exposure can influence functions and characteristics of the products. Confirm the product functions and characteristics in the evaluation stage.
11. WLCSP products should be used in light shielded environments. The light exposure can influence functions and characteristics of the products under operation or storage.
12. Warning for handling Gallium and Arsenic (GaAs) products (Applying to GaAs MMIC, Photo Reflector). These products use Gallium (Ga) and Arsenic (As) which are specified as poisonous chemicals by law. For the prevention of a hazard, do not burn, destroy, or process chemically to make them as gas or power. When the product is disposed of, please follow the related regulation and do not mix this with general industrial waste or household waste.
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